

PS9113

1 Mbps, OPEN COLLECTOR OUTPUT

R08DS0124EJ0301

Rev.3.01

Oct 29, 2018

HIGH CMR, INTELLIGENT POWER MODULE DRIVE 5-PIN SOP (SO-5) PHOTOCOUPLER

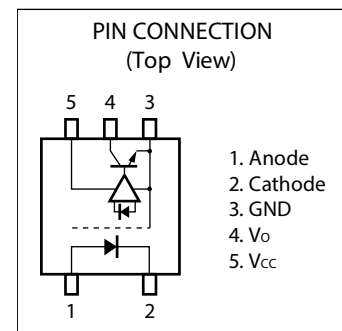
DESCRIPTION

The PS9113 is an optically coupled isolator containing an AlGaAs LED on the input side and a photo diode and a signal processing circuit on the output side on one chip.

The PS9113 is specified high CMR, high CTR and pulse width distortion with operating temperature. It is suitable for IPM drive.

FEATURES

- High instantaneous common mode rejection voltage ($CM_H, CM_L = \pm 15 \text{ kV}/\mu\text{s MIN.}$)
- Small package (SO-5)
- High-speed response ($t_{PHL} = 500 \text{ ns MAX.}, t_{PLH} = 750 \text{ ns MAX.}$)
- Propagation Delay Difference ($t_{PLH} - t_{PHL} = 270 \text{ ns TYP.}$)
- Pulse width distortion ($|t_{PHL} - t_{PLH}| = 270 \text{ ns TYP.}$)
- High isolation voltage ($BV = 3\,750 \text{ Vr.m.s.}$)
- Open collector output
- Ordering number of taping product: PS9113-F3: 2 500 pcs/reel
- Pb-Free product
- Safety standards
 - UL approved: UL1577, Single protection
 - CSA approved: CAN/CSA-C22.2 No. 62368-1, Basic insulation
 - VDE approved: DIN EN 60747-5-5 (Option)



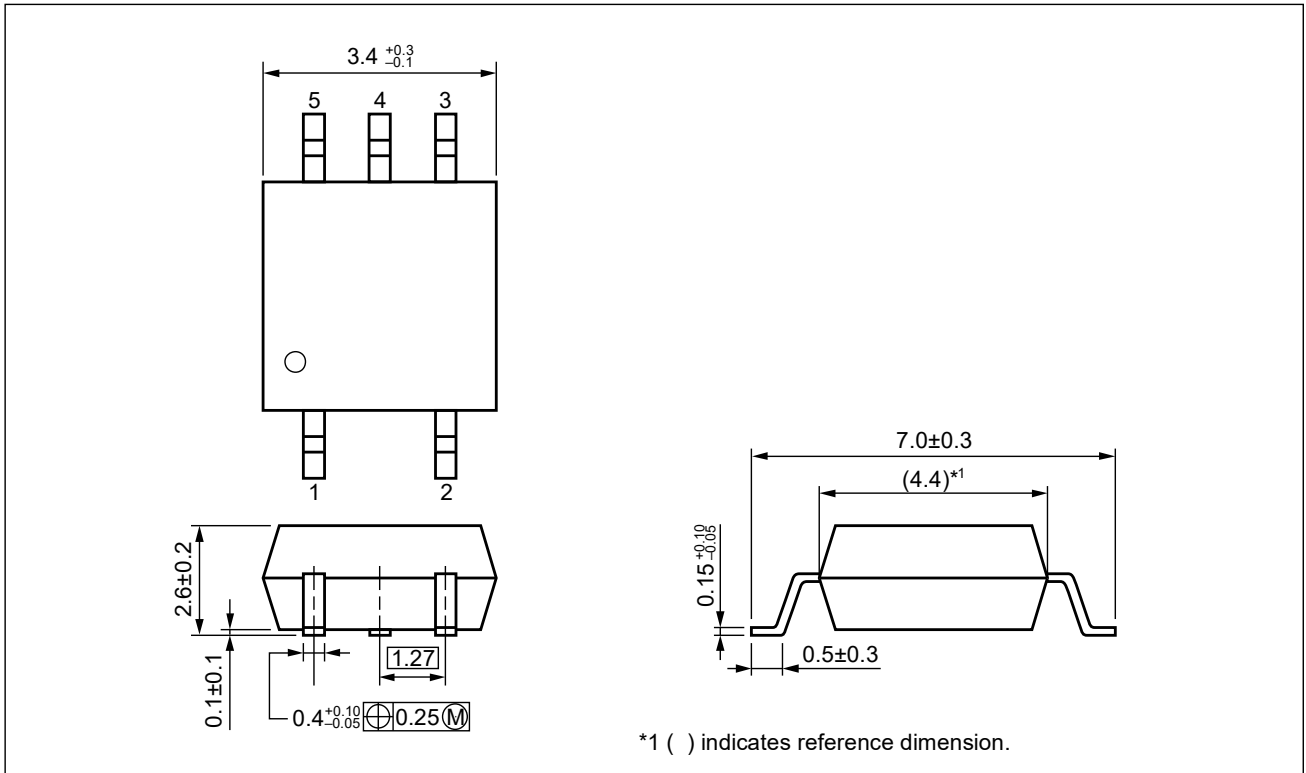
APPLICATIONS

- IPM Driver
- General purpose inverter

Start of mass production

Jan.2003

PACKAGE DIMENSIONS (UNIT: mm)

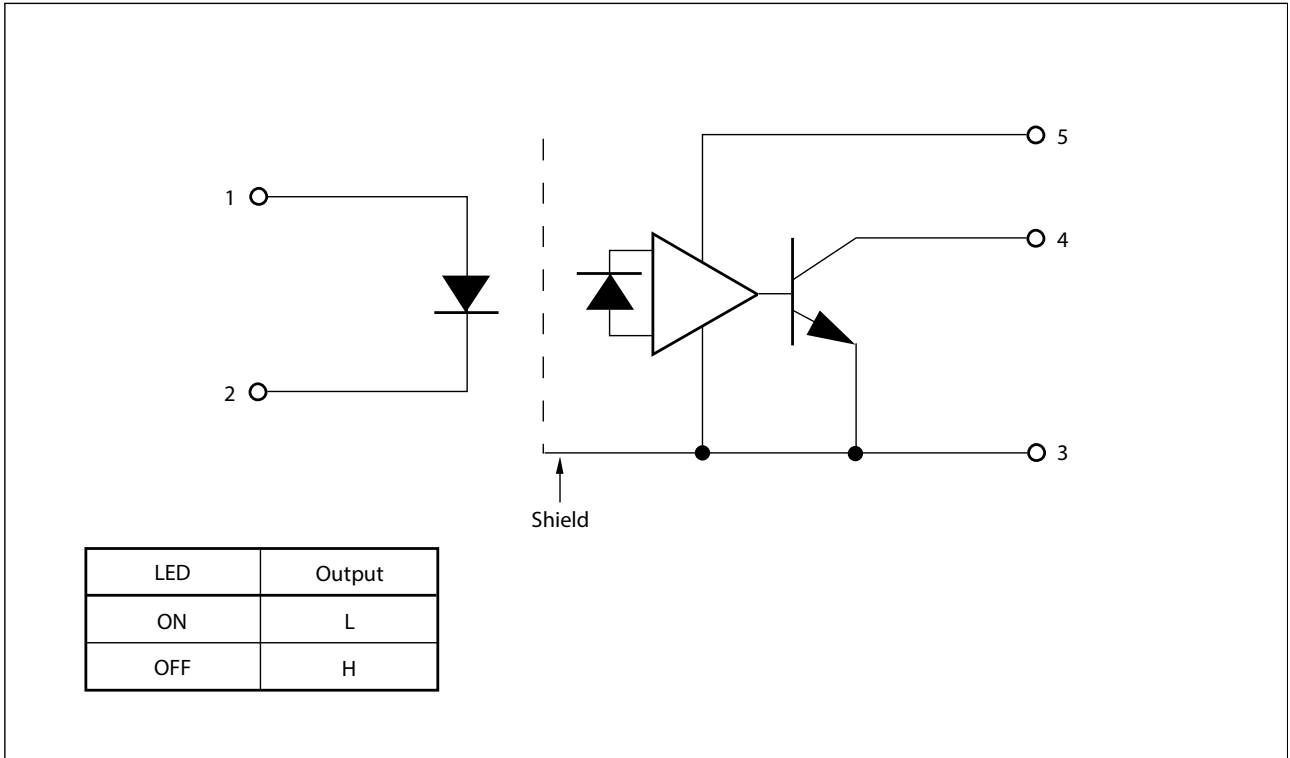


Weight: 0.08g (typ.)

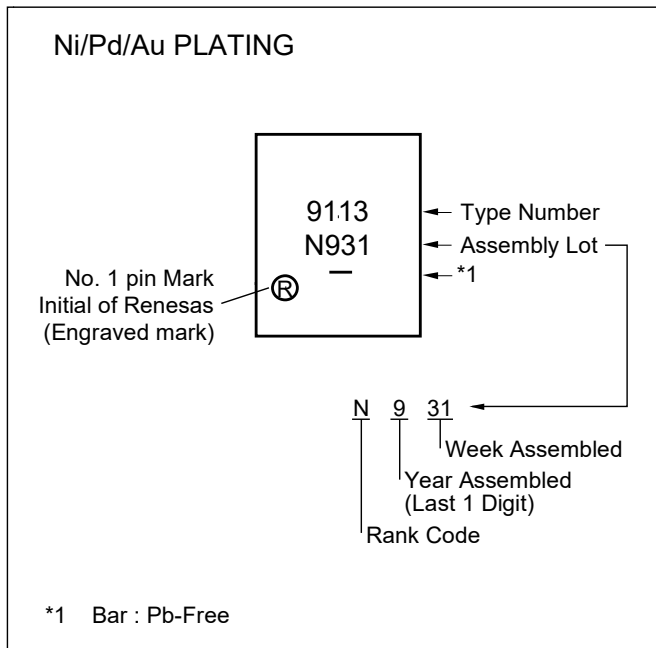
PHOTOCOUPLER CONSTRUCTION

| Parameter | PS9113 |
|---------------------------|--------|
| Air Distance (MIN.) | 4.2 mm |
| Creepage Distance (MIN.) | 4.2 mm |
| Isolation Distance (MIN.) | 0.2 mm |

FUNCTIONAL DIAGRAM



MARKING EXAMPLE



ORDERING INFORMATION

| Part Number | Order Number | Solder Plating Specification | Packing Style | Safety Standard Approval | Application Part Number ^{*1} |
|-------------|----------------|------------------------------|---------------------------------|--|---------------------------------------|
| PS9113 | PS9113-AX | Pb-Free (Ni/Pd/Au) | 20 pcs (Tape 20 pcs cut) | Standard products (UL, CSA approved) | PS9113 |
| PS9113-F3 | PS9113-F3-AX | | Embossed Tape 2500 pcs/reel | | |
| PS9113-V | PS9113-V-AX | | 20 pcs (Tape 20 pcs cut) | UL, CSA, DIN EN 60747-5-5 approved | |
| PS9113-V-F3 | PS9113-V-F3-AX | | Embossed Tape 2 500 pcs/reel | | |

Notes*: 1. For the application of the Safety Standard, following part number should be used.

ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

| Parameter | | Symbol | Ratings | Unit |
|---------------------------------|---------------------------------|------------------|-------------|---------|
| Diode | Forward Current ^{*1} | I _F | 25 | mA |
| | Reverse Voltage | V _R | 5 | V |
| Detector | Supply Voltage | V _{CC} | -0.5 to +25 | V |
| | Output Voltage | V _O | -0.5 to +25 | V |
| | Output Current | I _O | 15 | mA |
| | Power Dissipation ^{*2} | P _C | 100 | mW |
| Isolation Voltage ^{*3} | | BV | 3 750 | Vr.m.s. |
| Operating Ambient Temperature | | T _A | -40 to +100 | °C |
| Storage Temperature | | T _{stg} | -55 to +125 | °C |

- Notes*: 1. Reduced to 0.33 mA/°C at T_A = 70°C or more.
 2. Reduced to 1.9 mW/°C at T_A = 70°C or more.
 3. AC voltage for 1 minute at T_A = 25°C, RH = 60% between input and output.
 Pins 1-2 shorted together, 3-5 shorted together.

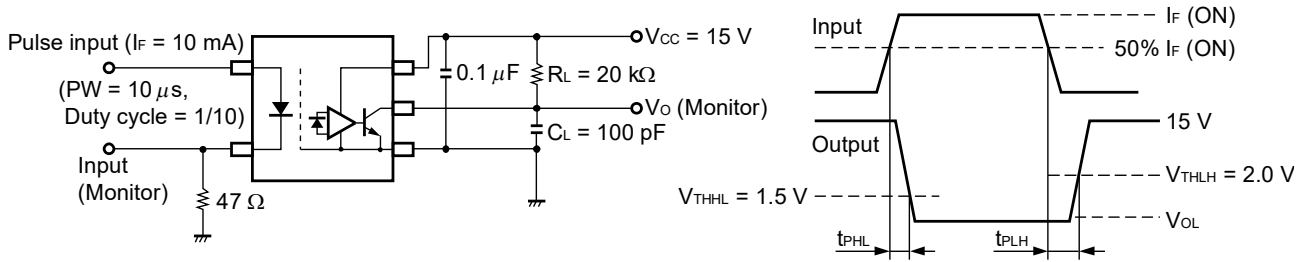
RECOMMENDED OPERATING CONDITIONS

| Parameter | Symbol | MIN. | TYP. | MAX. | Unit |
|--------------------------|----------|------|------|------|------|
| High Level Input Current | I_{FH} | 10 | | 20 | mA |
| Output Voltage | V_O | 0 | | 20 | V |
| Supply Voltage | V_{CC} | 4.5 | 15 | 20 | V |
| LED Off Voltage | V_F | 0 | | 0.8 | V |

ELECTRICAL CHARACTERISTICS ($T_A = -40$ to $+100^\circ\text{C}$, $V_{CC} = 15$ V, unless otherwise specified)

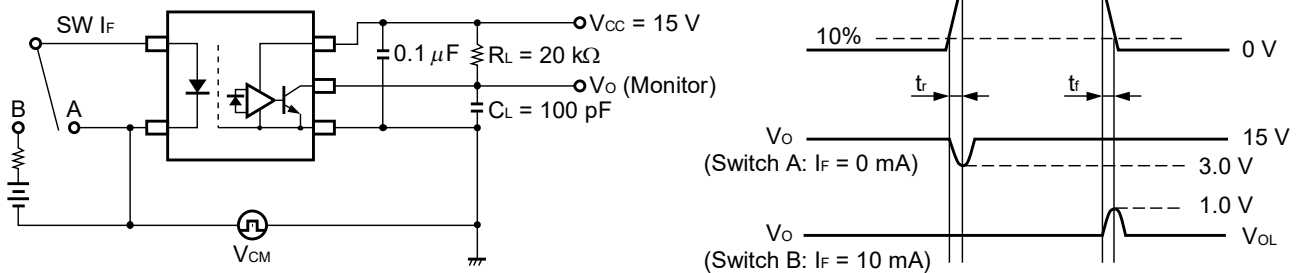
| Parameter | | Symbol | Conditions | MIN. | TYP.*1 | MAX. | Unit |
|---|--|--|---|-----------|--------|-------------------|---------------|
| Diode | Forward Voltage | V_F | $I_F = 10$ mA | 1.3 | 1.65 | 2.1 | V |
| | Reverse Current | I_R | $V_R = 3$ V | | | 200 | μA |
| | Terminal Capacitance | C_t | $V = 0$ V, $f = 1$ MHz, $T_A = 25^\circ\text{C}$ | | 30 | | pF |
| Detector | Low Level Output Voltage | V_{OL} | $I_F = 10$ mA, $I_{OL} = 2.4$ mA | | 0.13 | 0.6 | V |
| | High Level Output Current | I_{OH} | $V_{CC} = V_O = 20$ V, $V_F = 0.8$ V | | 0.01 | 50 | μA |
| | High Level Supply Current | I_{CCH} | $V_{CC} = 20$ V, $V_F = 0.8$ V, $V_O = \text{open}$ | | 1.0 | 1.3 | mA |
| | Low Level Supply Current | I_{CCL} | $V_{CC} = 20$ V, $I_F = 10$ mA, $V_O = \text{open}$ | | 1.0 | 1.3 | mA |
| Coupled | Threshold Input Current (H \rightarrow L) | I_{FHL} | $V_O = 0.8$ V, $I_O = 0.75$ mA | | 1.5 | 5.0 | mA |
| | Current Transfer Ratio (I_C/I_F) | CTR | $I_F = 10$ mA, $V_O = 0.6$ V | 44 | 110 | | % |
| | Isolation Resistance | R_{I-O} | $V_{I-O} = 1$ kV _{DC} , $R_H = 40$ to 60% , $T_A = 25^\circ\text{C}$ | 10^{11} | | | Ω |
| | Isolation Capacitance | C_{I-O} | $V = 0$ V, $f = 1$ MHz, $T_A = 25^\circ\text{C}$ | | 0.6 | | pF |
| | Propagation Delay Time (H \rightarrow L)*2 | t_{PHL} | $I_F = 10$ mA, $R_L = 20$ k Ω , $C_L = 100$ pF, $V_{THHL} = 1.5$ V, $V_{THLH} = 2.0$ V | | 250 | 500 | ns |
| | Propagation Delay Time (L \rightarrow H)*2 | t_{PLH} | | | 520 | 750 | |
| | Propagation Delay Difference Between Any 2 Parts | $t_{PLH} - t_{PHL}$ | | -200 | 270 | 650 | |
| | Pulse Width Distortion (PWD)*2 | $ t_{PHL} - t_{PLH} $ | | | 270 | 650 | |
| Common Mode Transient Immunity at High Level Output*3 | CM_H | $T_A = 25^\circ\text{C}$, $I_F = 0$ mA, $V_O > 3.0$ V, $V_{CM} = 1.5$ kV, $R_L = 20$ k Ω , $C_L = 100$ pF | 15 | | | kV/ μs | |
| Common Mode Transient Immunity at Low Level Output*3 | CM_L | $T_A = 25^\circ\text{C}$, $I_F = 10$ mA, $V_O < 1.0$ V, $V_{CM} = 1.5$ kV, $R_L = 20$ k Ω , $C_L = 100$ pF | -15 | | | kV/ μs | |

- Notes*: 1. Typical values at $T_A = 25^\circ\text{C}$.
 2. Test circuit for propagation delay time



C_L includes probe and stray wiring capacitance.

3. Test circuit for common mode transient immunity



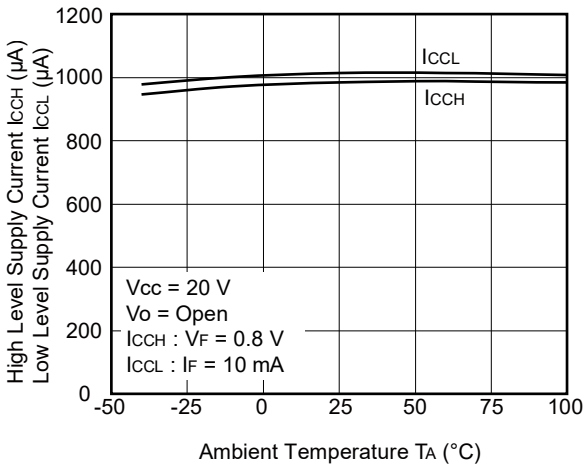
C_L includes probe and stray wiring capacitance.

USAGE CAUTIONS

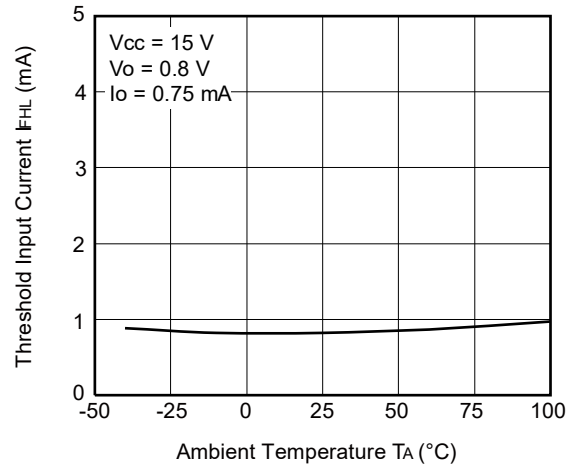
1. This product is weak for static electricity by designed with high-speed integrated circuit so protect against static electricity when handling.
2. By-pass capacitor of $0.1 \mu\text{F}$ is used between V_{CC} and GND near device. Also, ensure that the distance between the leads of the photocopier and capacitor is no more than 10 mm.
3. Avoid storage at a high temperature and high humidity.
4. Do not use adhesives or coating materials including halogens to fix this device.

TYPICAL CHARACTERISTICS (T_A = 25°C unless otherwise specified)

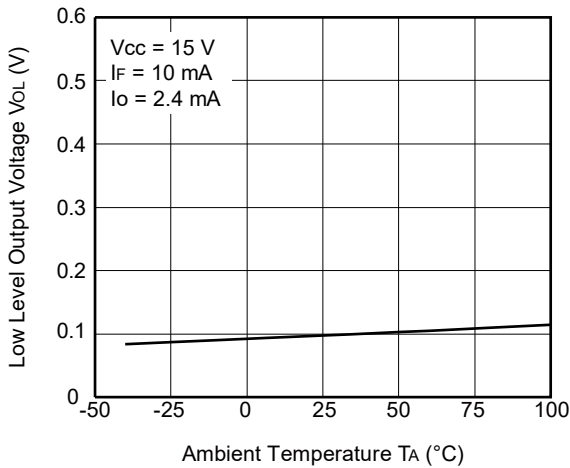
SUPPLY CURRENT vs. AMBIENT TEMPERATURE



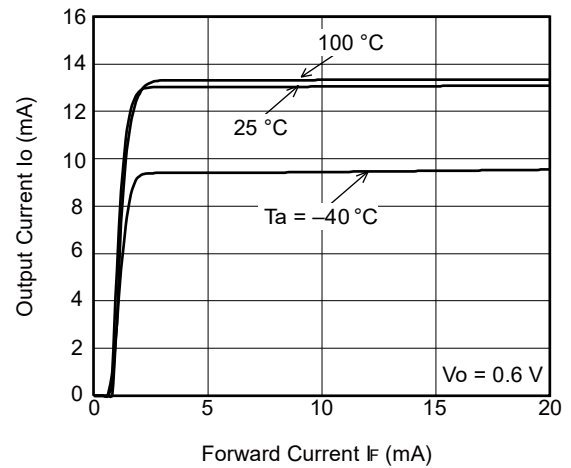
THRESHOLD INPUT CURRENT vs. AMBIENT TEMPERATURE



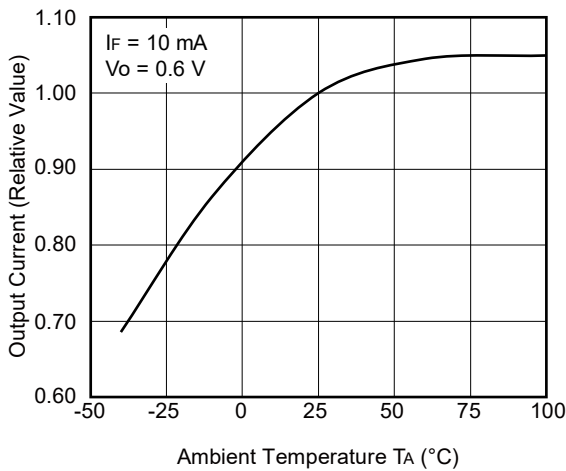
LOW LEVEL OUTPUT VOLTAGE vs. AMBIENT TEMPERATURE



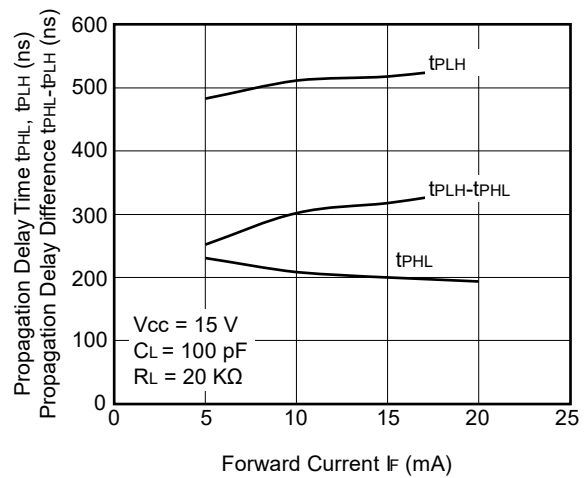
OUTPUT CURRENT vs. FORWARD CURRENT



OUTPUT CURRENT vs. AMBIENT TEMPERATURE

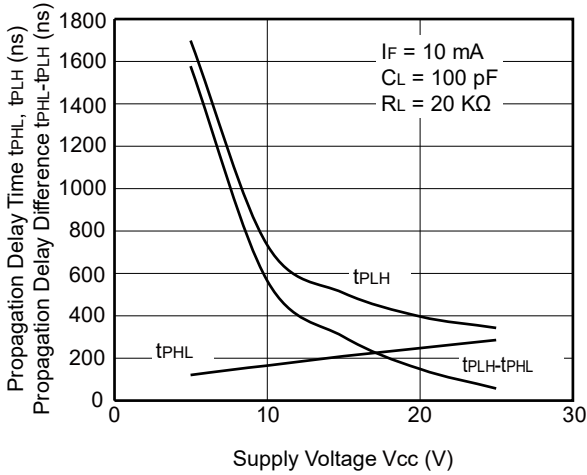


PROPAGATION DELAY TIME, PROPAGATION DELAY DIFFERENCE vs. FORWARD CURRENT

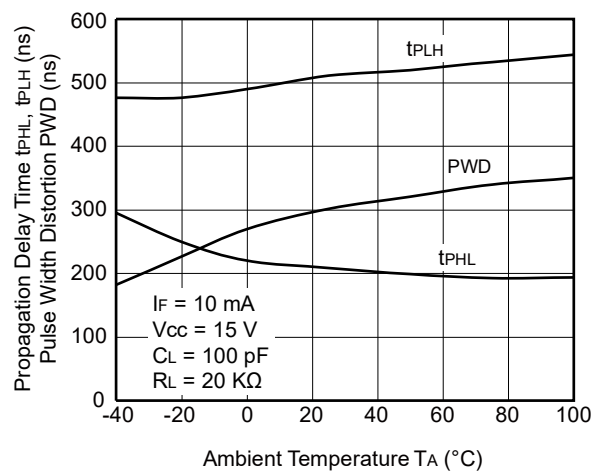


Remark The graphs indicate nominal characteristics.

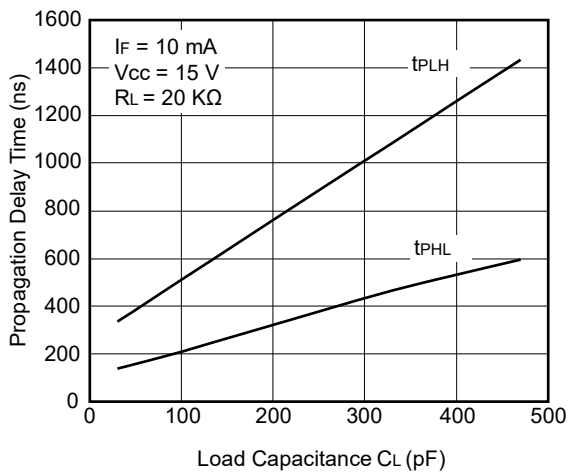
PROPAGATION DELAY TIME,
PROPAGATION DELAY DIFFERENCE
vs. SUPPLY VOLTAGE



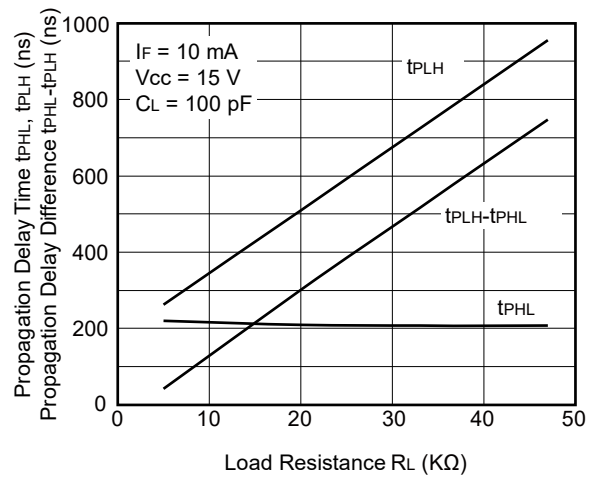
PROPAGATION DELAY TIME,
PULSE WIDTH DISTORTION
vs. AMBIENT TEMPERATURE



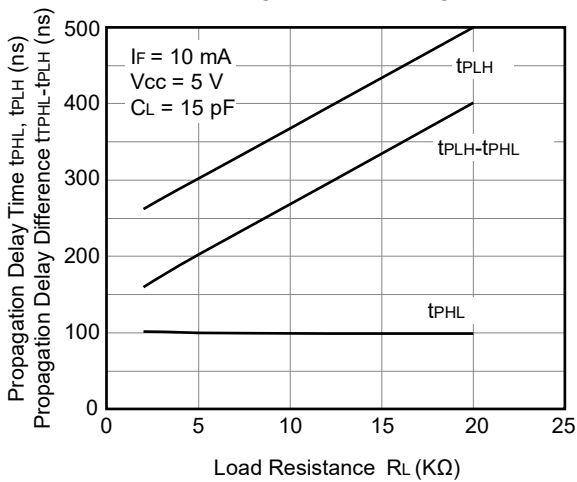
PROPAGATION DELAY TIME
vs. LOAD CAPACITANCE



PROPAGATION DELAY TIME,
PROPAGATION DELAY DIFFERENCE
vs. LOAD RESISTANCE



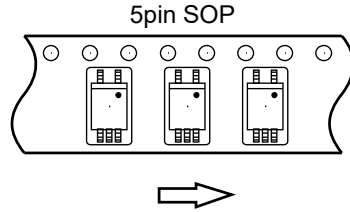
PROPAGATION DELAY TIME,
PROPAGATION DELAY DIFFERENCE
vs. LOAD RESISTANCE



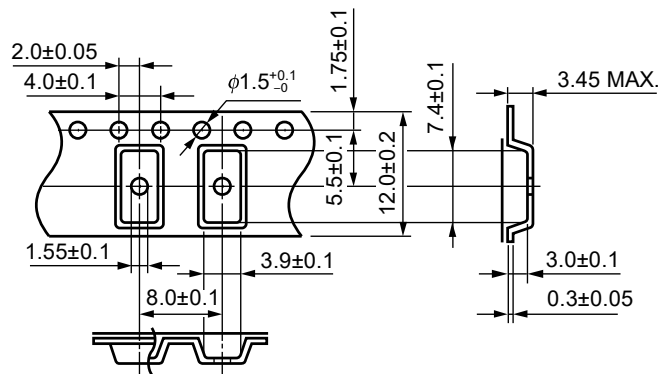
Remark The graphs indicate nominal characteristics.

TAPING SPECIFICATIONS (UNIT: mm)

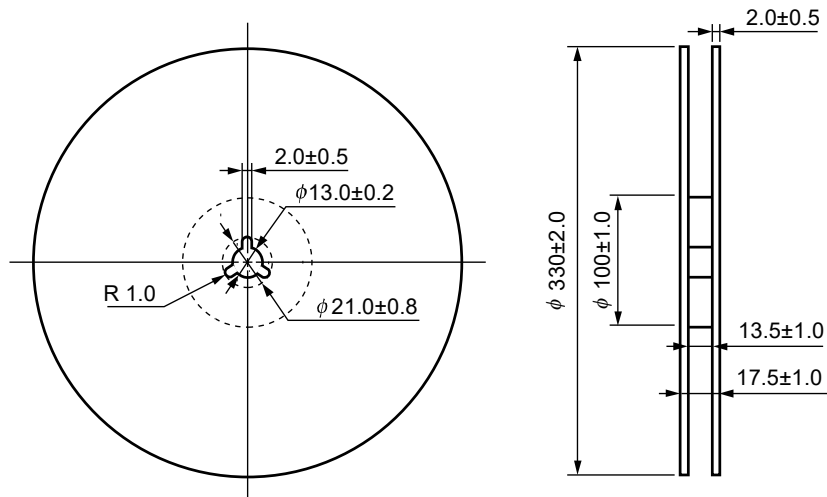
Tape Direction



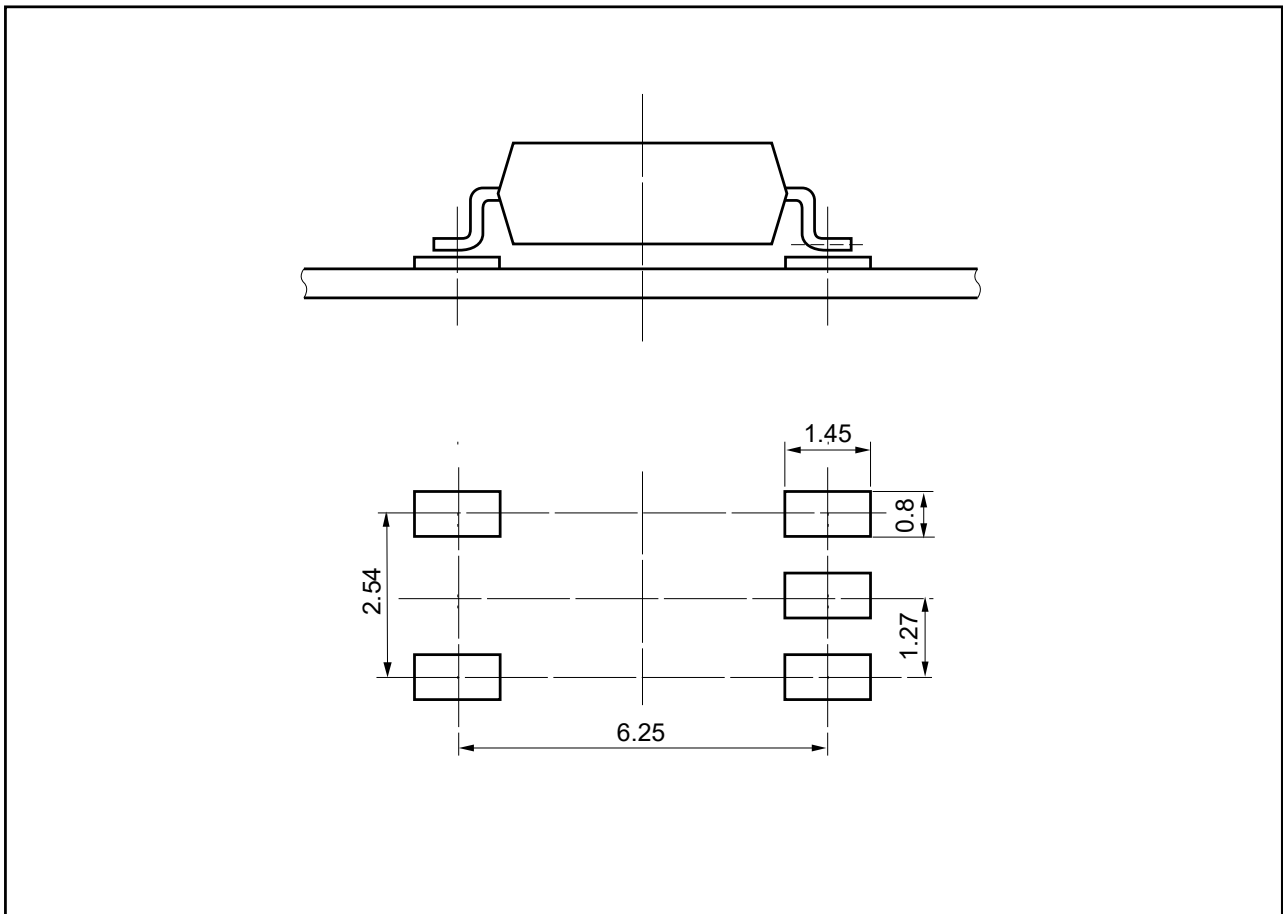
Outline and Dimensions (Tape)



Outline and Dimensions (Reel)



Packing: 2 500 pcs/reel

RECOMMENDED MOUNT PAD DIMENSIONS (UNIT: mm)

【5pin SOP】

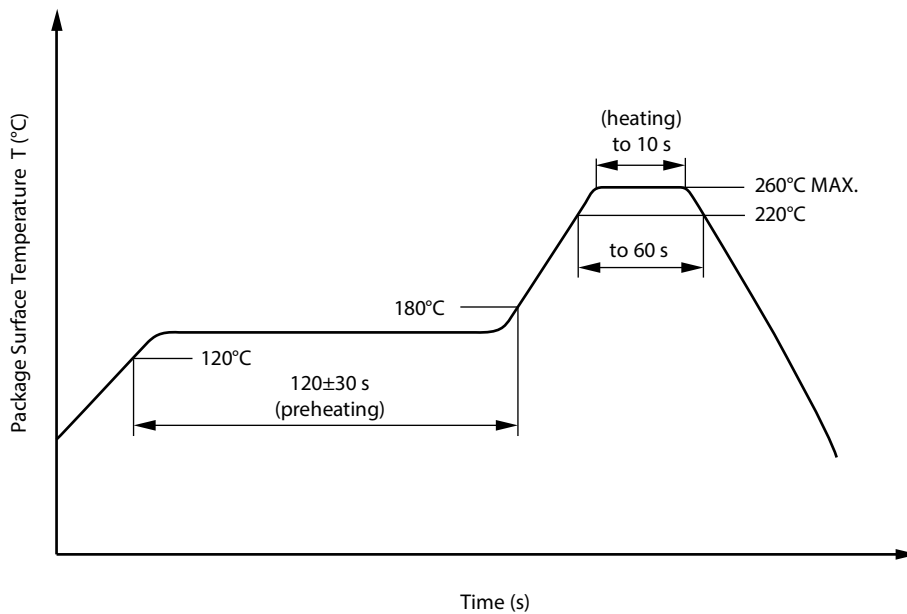
NOTES ON HANDLING

1. Recommended soldering conditions

(1) Infrared reflow soldering

- Peak reflow temperature 260°C or below (package surface temperature)
- Time of peak reflow temperature 10 seconds or less
- Time of temperature higher than 220°C 60 seconds or less
- Time to preheat temperature from 120 to 180°C 120±30 s
- Number of reflows Three
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

Recommended Temperature Profile of Infrared Reflow



(2) Wave soldering

- Temperature 260°C or below (molten solder temperature)
- Time 10 seconds or less
- Preheating conditions 120°C or below (package surface temperature)
- Number of times One (Allowed to be dipped in solder including plastic mold portion.)
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(3) Soldering by Soldering Iron

- Peak Temperature (lead part temperature) 350°C or below
- Time (each pins) 3 seconds or less
- Flux Rosin flux containing small amount of chlorine (The flux with a maximum chlorine content of 0.2 Wt% is recommended.)

(a) Soldering of leads should be made at the point 1.5 to 2.0 mm from the root of the lead

(b) Please be sure that the temperature of the package would not be heated over 100°C

(4) Cautions

Fluxes

Avoid removing the residual flux with freon-based and halogens-based (chlorine-based) cleaning solvent .

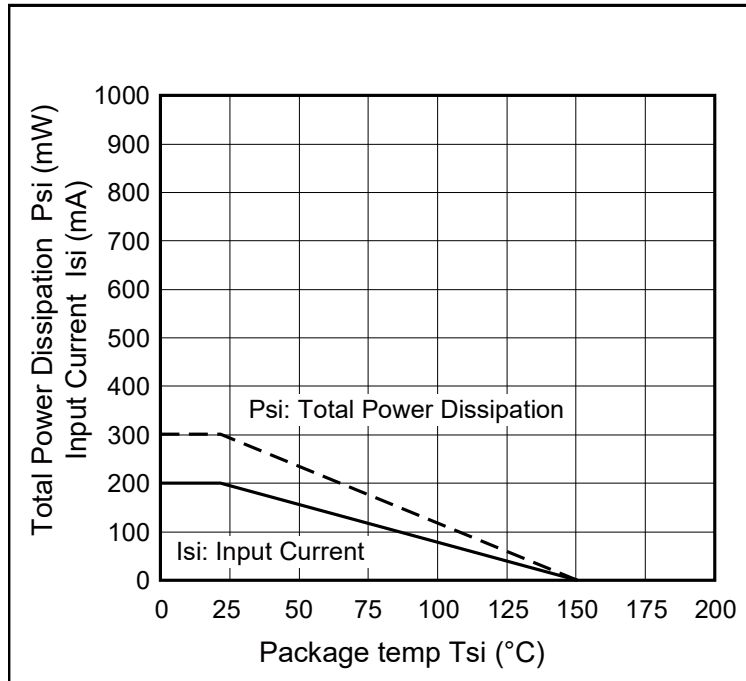
2. Cautions regarding noise

Be aware that when voltage is applied suddenly between the photocoupler's input and output or between collector-emitters at startup, the output transistor may enter the on state, even if the voltage is within the absolute maximum ratings.

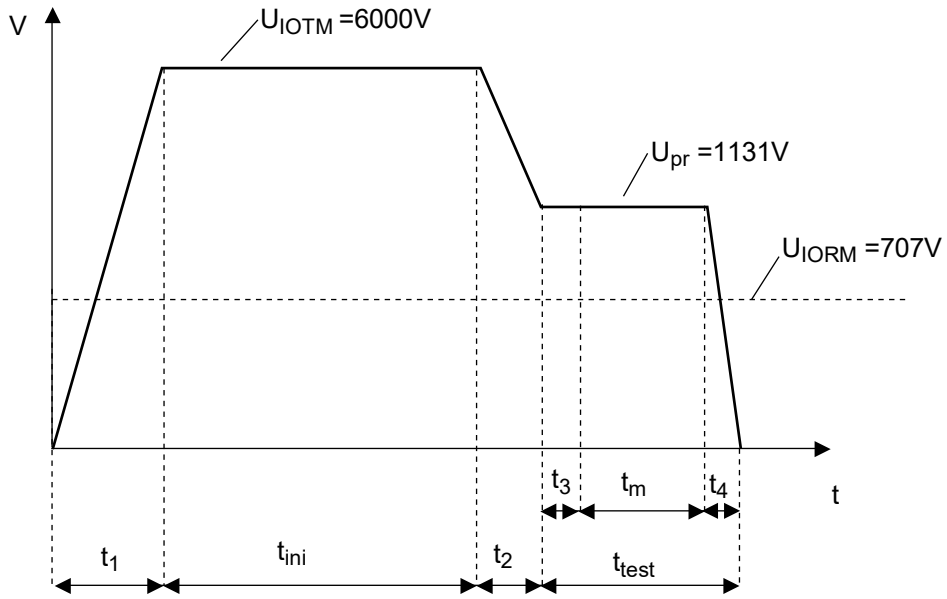
SPECIFICATION OF VDE MARKS LICENSE DOCUMENT

| Parameter | Symbol | Rating | Unit |
|---|--|-----------------------------|----------------------------|
| Climatic test class (IEC 60068-1/DIN EN 60068-1) | | 40/100/21 | |
| Dielectric strength maximum operating isolation voltage Test voltage (partial discharge test, procedure a for type test and random test) $U_{pr} = 1.6 \times U_{IORM}, Pd < 5 \text{ pC}$ | U_{IORM} U_{pr} | 707 1131 | V_{peak} V_{peak} |
| Test voltage (partial discharge test, procedure b for all devices) $U_{pr} = 1.875 \times U_{IORM}, Pd < 5 \text{ pC}$ | U_{pr} | 1 326 | V_{peak} |
| Highest permissible overvoltage | U_{IOTM} | 6 000 | V_{peak} |
| Degree of pollution (DIN EN 60664-1 VDE 0110 Part 1) | | 2 | |
| Comparative tracking index ((IEC 60112/DIN EN 60112 (VDE 0303 Part 11)) | CTI | 175 | |
| Material group (DIN EN 60664-1 VDE 0110 Part 1) | | III a | |
| Storage temperature range | Tstg | -55 to +125 | °C |
| Operating temperature range | T_A | -40 to +100 | °C |
| Isolation resistance, minimum value $V_{IO} = 500 \text{ V dc at } T_A = 25^\circ\text{C}$ $V_{IO} = 500 \text{ V dc at } T_A \text{ MAX. at least } 100^\circ\text{C}$ | Ris MIN. Ris MIN. | 10^{12} 10^{11} | Ω Ω |
| Safety maximum ratings (maximum permissible in case of fault, see thermal derating curve) Package temperature Current (input current I_F , $Psi = 0$) Power (output or total power dissipation) Isolation resistance $V_{IO} = 500 \text{ V dc at } T_A = T_{si}$ | T_{si} I_{si} P_{si} Ris MIN. | 150 200 300 10^9 | °C mA mW Ω |

Dependence of maximum safety ratings with package temperature

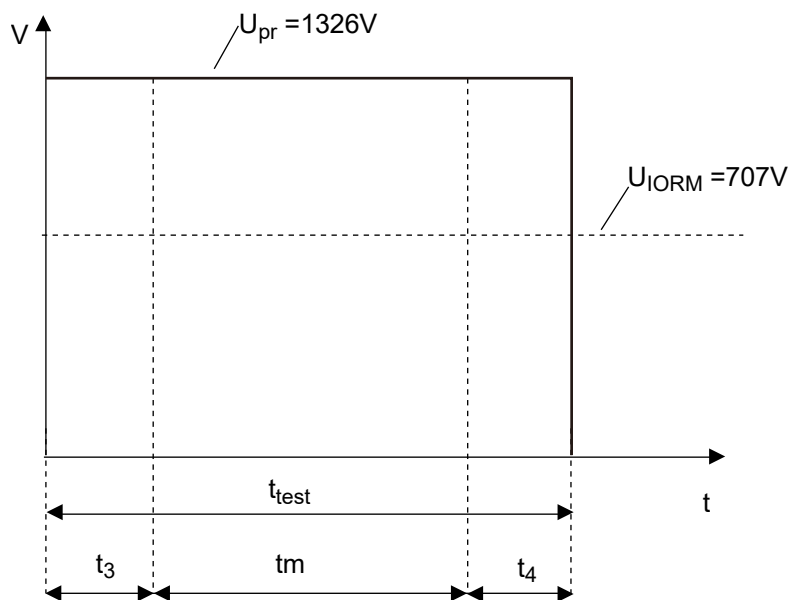


Method a) Destructive Test, Type and Sample Test



$t_1, t_2 = 1 \text{ to } 10 \text{ sec}$
 $t_3, t_4 = 1 \text{ sec}$
 $t_m(\text{PARTIAL DISCHARGE}) = 10 \text{ sec}$
 $t_{\text{test}} = 12 \text{ sec}$
 $t_{\text{ini}} = 60 \text{ sec}$

Method b) Non-destructive Test, 100% Production Test



$t_3, t_4 = 0.1 \text{ sec}$
 $t_m(\text{PARTIAL DISCHARGE}) = 1.0 \text{ sec}$
 $t_{\text{test}} = 1.2 \text{ sec}$

| | |
|------------------------------|--|
| Caution GaAs Products | <p>This product uses gallium arsenide (GaAs). GaAs vapor and powder are hazardous to human health if inhaled or ingested, so please observe the following points.</p> <ul style="list-style-type: none">• Follow related laws and ordinances when disposing of the product. If there are no applicable laws and/or ordinances, dispose of the product as recommended below.<ol style="list-style-type: none">1. Commission a disposal company able to (with a license to) collect, transport and dispose of materials that contain arsenic and other such industrial waste materials.2. Exclude the product from general industrial waste and household garbage, and ensure that the product is controlled (as industrial waste subject to special control) up until final disposal.• Do not burn, destroy, cut, crush, or chemically dissolve the product.• Do not lick the product or in any way allow it to enter the mouth. |
|------------------------------|--|

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